

TOSHIBA Field-Effect Transistor Silicon P-Channel MOS Type (U-MOS VI)

# SSM3J46CTB

○ Power Management Switch Applications

- 1.5 V drive
- Low ON-resistance:  $R_{DS(ON)} = 250 \text{ m}\Omega$  (max) (@ $V_{GS} = -1.5 \text{ V}$ )  
 $R_{DS(ON)} = 178 \text{ m}\Omega$  (max) (@ $V_{GS} = -1.8 \text{ V}$ )  
 $R_{DS(ON)} = 133 \text{ m}\Omega$  (max) (@ $V_{GS} = -2.5 \text{ V}$ )  
 $R_{DS(ON)} = 103 \text{ m}\Omega$  (max) (@ $V_{GS} = -4.5 \text{ V}$ )

**Absolute Maximum Ratings (Ta = 25°C)**

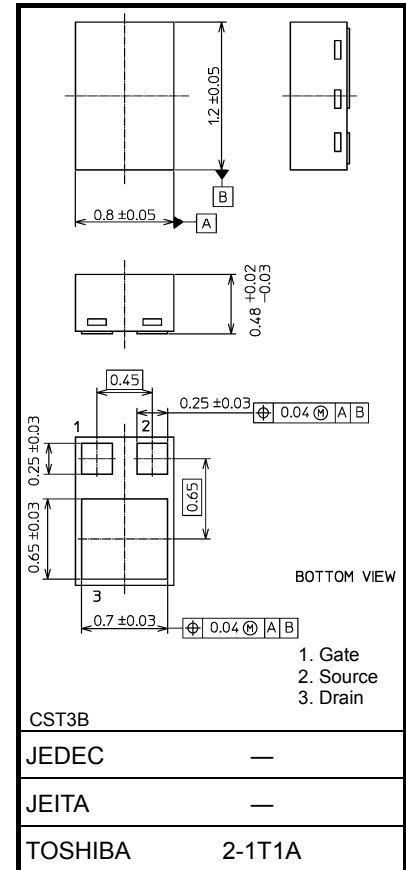
| Characteristic            | Symbol         | Rating     | Unit |
|---------------------------|----------------|------------|------|
| Drain-Source voltage      | $V_{DSS}$      | -20        | V    |
| Gate-Source voltage       | $V_{GSS}$      | $\pm 8$    | V    |
| Drain current             | DC             | $I_D$      | -2.0 |
|                           | Pulse          | $I_{DP}$   | -4.0 |
| Power dissipation         | $P_D$ (Note 1) | 1000       | mW   |
| Channel temperature       | $T_{ch}$       | 150        | °C   |
| Storage temperature range | $T_{stg}$      | -55 to 150 | °C   |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

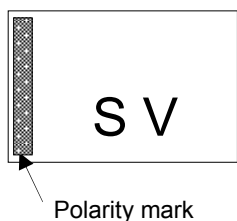
Note 1: Mounted on a FR4 board.  
 (25.4 mm × 25.4 mm × 1.6 mm, Cu Pad: 645 mm<sup>2</sup>)

Unit: mm

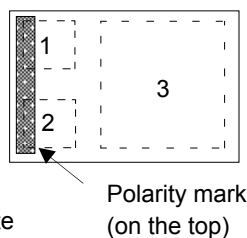


Weight: 1.5 mg (typ.)

**Marking (top view)**

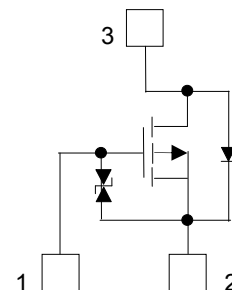


**Pin Condition (top view)**



- 1. Gate
  - 2. Source
  - 3. Drain
- \*Electrodes: on the bottom

**Equivalent Circuit**



## Electrical Characteristics (Ta = 25°C)

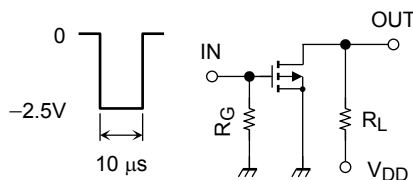
| Characteristic                 | Symbol        | Test Conditions  | Min   | Typ.  | Max     | Unit          |    |
|--------------------------------|---------------|--|---|-------|---------|---------------|----|
| Drain-Source breakdown voltage | $V_{(BR)DSS}$ | $I_D = -1 \text{ mA}, V_{GS} = 0 \text{ V}$                                  | -20   | —     | —       | V             |    |
|                                | $V_{(BR)DSX}$ | $I_D = -1 \text{ mA}, V_{GS} = 5 \text{ V}$ (Note 3)                         | -15   | —     | —       | V             |    |
| Drain cut-off current          | $I_{DSS}$     | $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$                               | —   | —     | -1      | $\mu\text{A}$ |    |
| Gate leakage current           | $I_{GSS}$     | $V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$                             | —   | —     | $\pm 1$ | $\mu\text{A}$ |    |
| Gate threshold voltage         | $V_{th}$      | $V_{DS} = -3 \text{ V}, I_D = -1 \text{ mA}$                                 | -0.3  | —     | -1.0    | V             |    |
| Forward transfer admittance    | $ Y_{fs} $    | $V_{DS} = -3 \text{ V}, I_D = -1.0 \text{ A}$ (Note 2)                       | —   | 5.2   | —       | S             |    |
| Drain-source ON-resistance     | $R_{DS(ON)}$  | $I_D = -1.5 \text{ A}, V_{GS} = -4.5 \text{ V}$ (Note 2)                     | —   | 88.5  | 103     | m $\Omega$    |    |
|                                |               | $I_D = -1.0 \text{ A}, V_{GS} = -2.5 \text{ V}$ (Note 2)                     | —   | 107.5 | 133     |               |    |
|                                |               | $I_D = -0.5 \text{ A}, V_{GS} = -1.8 \text{ V}$ (Note 2)                     | —   | 130   | 178     |               |    |
|                                |               | $I_D = -0.25 \text{ A}, V_{GS} = -1.5 \text{ V}$ (Note 2)                    | —   | 151   | 250     |               |    |
| Input capacitance              | $C_{iss}$     | $V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}$<br>$f = 1 \text{ MHz}$        | —   | 290   | —       | pF            |    |
| Output capacitance             | $C_{oss}$     |  | —   | 44    | —       |               |    |
| Reverse transfer capacitance   | $C_{rss}$     |  | —   | 32    | —       |               |    |
| Switching time                 | Turn-on time  | $t_{on}$   | $V_{DD} = -10 \text{ V}, I_D = -0.5 \text{ A}$<br>$V_{GS} = 0 \text{ to } -2.5 \text{ V}, R_G = 4.7 \Omega$ | —     | 13.4    | —             | ns |
|                                | Turn-off time | $t_{off}$  |   | —     | 46.2    | —             |    |
| Total Gate Charge              | $Q_g$         | $V_{DD} = -10 \text{ V}, I_D = -2.0 \text{ A},$<br>$V_{GS} = -4.5 \text{ V}$ | —   | 4.7   | —       | nC            |    |
| Gate-Source Charge             | $Q_{gs1}$     |  | —   | 0.4   | —       |               |    |
| Gate-Drain Charge              | $Q_{gd}$      |  | —   | 1.0   | —       |               |    |
| Drain-Source forward voltage   | $V_{DSF}$     | $I_D = 2.0 \text{ A}, V_{GS} = 0 \text{ V}$ (Note 2)                         | —   | 0.9   | 1.2     | V             |    |

Note2: Pulse test

Note3: If a forward bias is applied between gate and source, this device enters  $V_{(BR)DSX}$  mode. Note that the drain-source breakdown voltage is lowered in this mode.

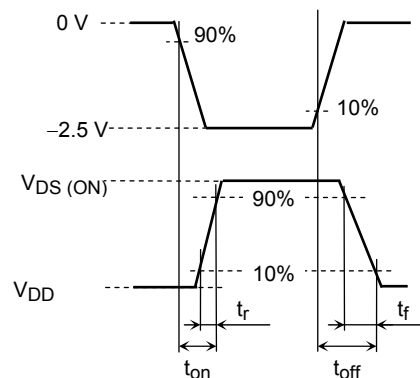
## Switching Time Test Circuit

### (a) Test Circuit



$V_{DD} = -10 \text{ V}$   
 $R_G = 4.7 \Omega$   
 Duty  $\leq 1\%$   
 $V_{IN}$ :  $t_r, t_f < 5 \text{ ns}$   
 Common Source  
 $T_a = 25^\circ\text{C}$

### (b) $V_{IN}$



### (c) $V_{OUT}$

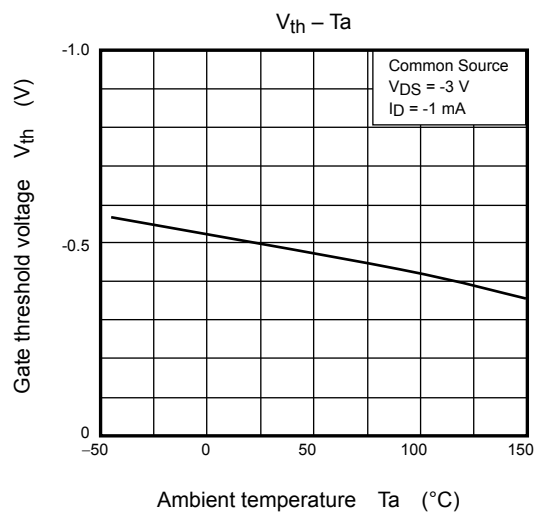
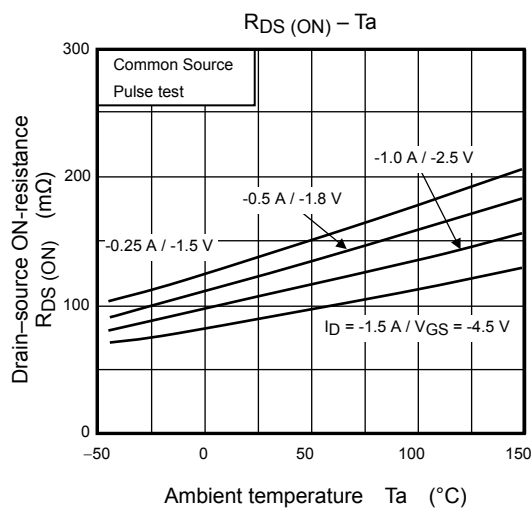
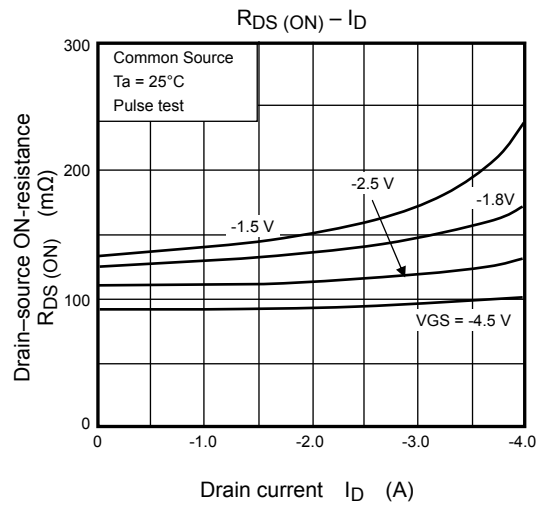
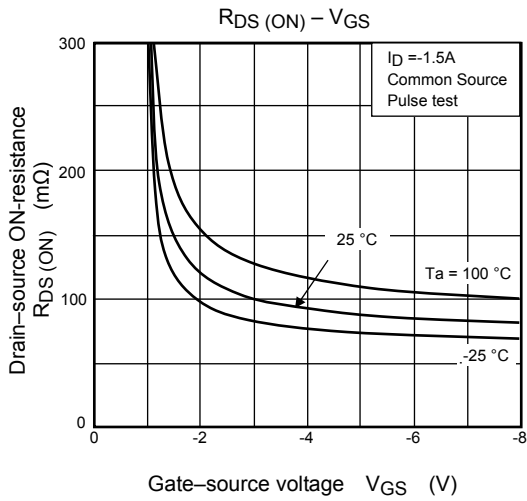
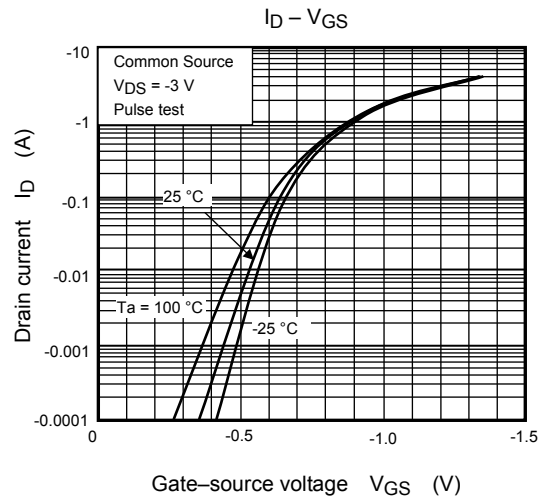
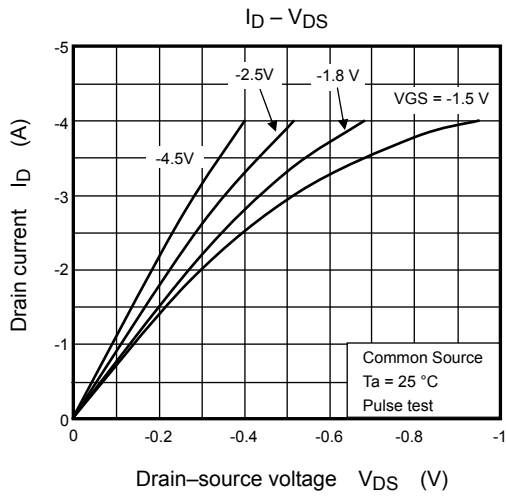
## Notice on Usage

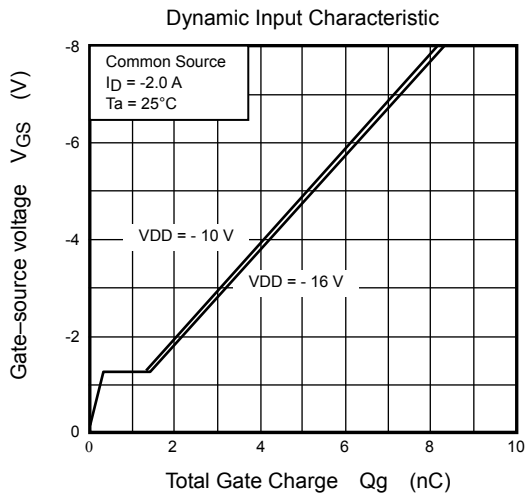
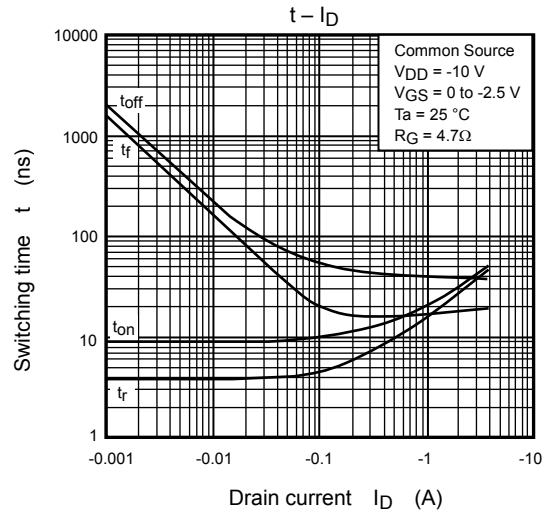
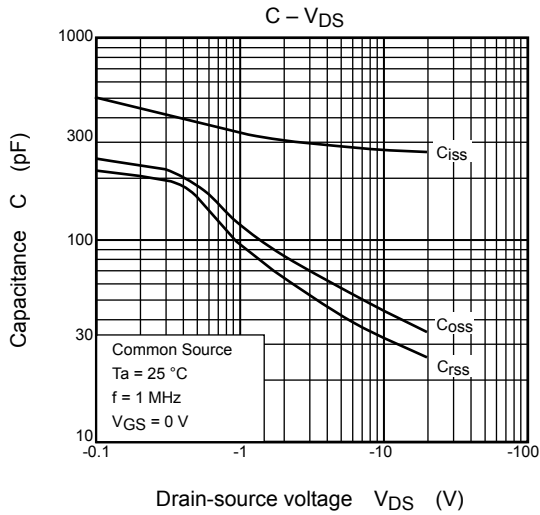
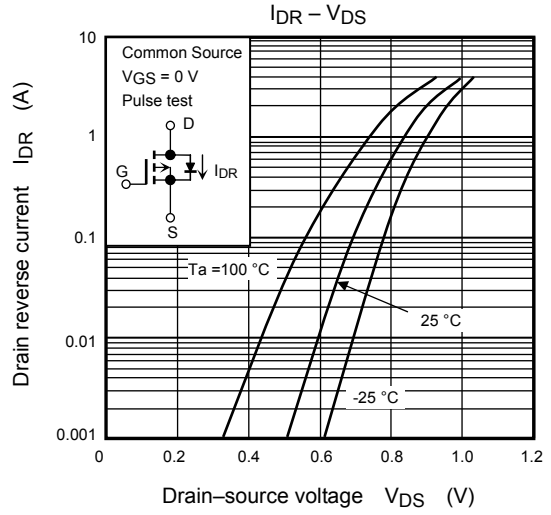
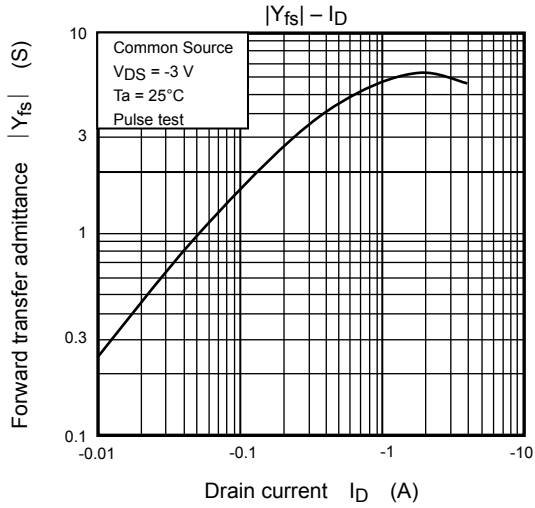
$V_{th}$  can be expressed as the voltage between gate and source when the low operating current value is  $I_D = -1 \text{ mA}$  for this product. For normal switching operation,  $V_{GS(ON)}$  requires a higher voltage than  $V_{th}$  and  $V_{GS(OFF)}$  requires a lower voltage than  $V_{th}$ . (The relationship can be established as follows:  $V_{GS(OFF)} < V_{th} < V_{GS(ON)}$ .)

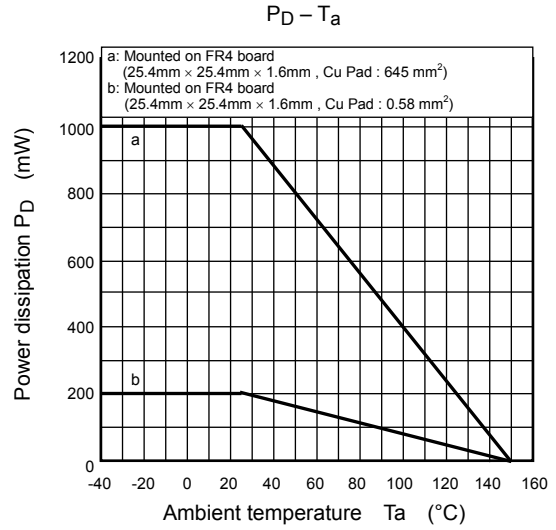
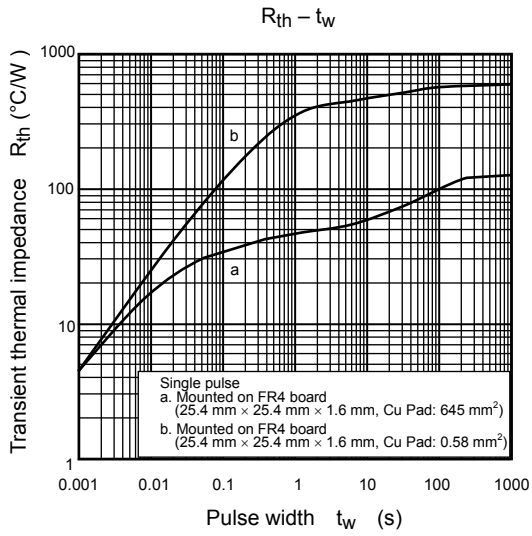
Take this into consideration when using the device.

## Handling Precaution

When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.







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